

## FDN5630

### 60V N-Channel PowerTrench® MOSFET

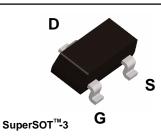
#### **General Description**

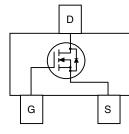
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers.

This MOSFET features very low R<sub>DS(ON)</sub> in a small SOT23 footprint. Fairchild's PowerTrench technology provides faster switching than other MOSFETs with comparable R<sub>DS(ON)</sub> specifications. The result is higher overall efficiency with less board space.

#### Applications

- DC/DC converter
- Motor drives





• 1.7 A, 60 V.  $R_{DS(ON)} = 0.100 \Omega @ V_{GS} = 10 V$ 

 $\mathsf{R}_{_{\mathsf{DS}(\mathsf{ON})}} = 0.120 \ \Omega \ @ \ \mathsf{V}_{_{\mathsf{GS}}} = \ 6 \ \mathsf{V}.$ 

• Optimized for use in high frequency DC/DC converters.

SuperSOT<sup>™</sup> - 3 provides low R<sub>DS(ON)</sub> in SOT23 footprint.

## Absolute Maximum Ratings T<sub>4</sub> = 25 C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V <sub>DSS</sub>	Drain-Source Voltage		60	V	
V <sub>GSS</sub>	Gate-Source Voltage		±20	V	
ID	Drain Current - Continuous	(Note 1a)	1.7	A	
	- Pulsed		10		
PD	Power Dissipation for Single Operation	(Note 1a)	0.5	W	
		(Note 1b)	0.46		
TJ, T <sub>stg</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C	

**Features** 

• Low gate charge.

· Very fast switching.

#### **Thermal Characteristics**

R <sub>e</sub> JA	Thermal Resistance, Junction-to-Ambient	(Note 1a)	250	°C/W
$R_{_{\!\!\!\!\!\Theta}JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	75	°C/W

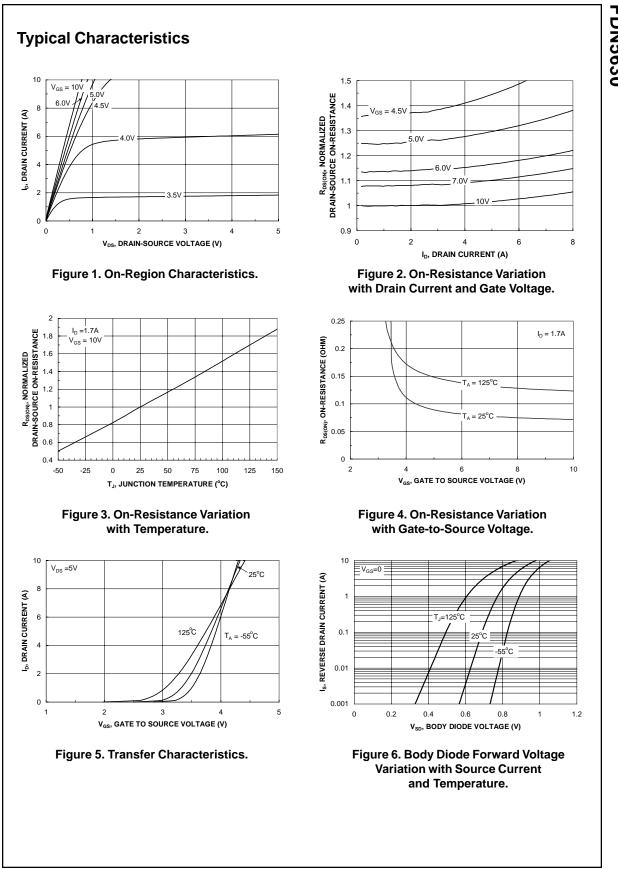
## Package Marking and Ordering Information

Device Marking	e Marking Device		Reel Size Tape Width		
5630	FDN5630	7	8mm	3000 units	

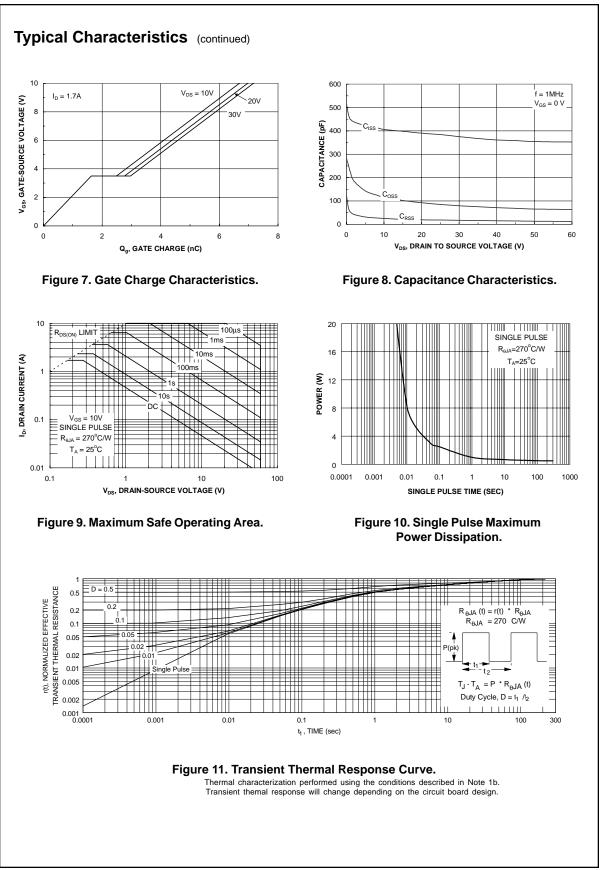
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## October 2015

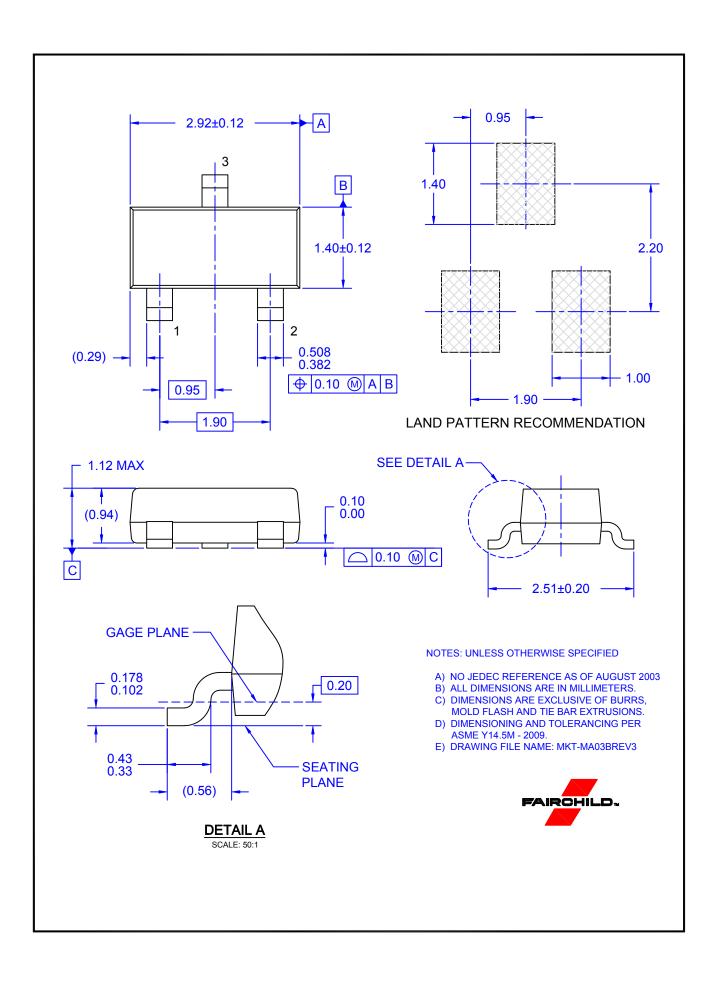
teristics rain-Source Breakdown Voltage reakdown Voltage Temperature	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	60			
rain-Source Breakdown Voltage		60	<u> </u>	<u> </u>	
reakdown Voltage Temperature					V
oefficient	$I_D = 250 \ \mu\text{A}, \text{Referenced to } 25^{\circ}\text{C}$		63		mV/°C
ero Gate Voltage Drain Current	$V_{DS} = 48 V, V_{GS} = 0 V$			1	μA
ate-Body Leakage Current, orward	$V_{GS} = 20 \text{ V},  V_{DS} = 0 \text{ V}$			100	nA
ate-Body Leakage Current, everse	$V_{GS} = -20 V, V_{DS} = 0 V$			-100	nA
teristics (Note 2)					
ate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1	2.4	3	V
ate Threshold Voltage emperature Coefficient	$I_D = 250 \ \mu\text{A}, \text{Referenced to } 25^\circ\text{C}$		-6.9		mV/°C
tatic Drain-Source n-Resistance	$ \begin{array}{l} V_{GS} = 10 \; V, \; I_D = 1.7 \; A \\ V_{GS} = 10 \; V, \; I_D = 1.7 \; A, \; T_J = 125^\circ C \\ V_{GS} = 6 \; V, \; I_D = 1.6 \; A \end{array} $		0.073 0.127 0.083	0.100 0.180 0.120	Ω
n-State Drain Current	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 1.7 V	5			Α
orward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1.7 \text{ A}$		6		S
haracteristics	<u>.</u>				
put Capacitance	$V_{DS} = 15 V, V_{GS} = 0 V,$		400	560	pF
utput Capacitance	f = 1.0 MHz		65	95	pF
everse Transfer Capacitance	1		27	40	pF
	-				
urn-On Delay Time	$V_{DD} = 30 V, I_D = 1 A,$		10	20	ns
urn-On Rise Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		6	15	ns
urn-Off Delay Time	1		15	28	ns
urn-Off Fall Time	1		5	15	ns
otal Gate Charge			7	10	nC
ate-Source Charge			1.6		nC
ate-Drain Charge	1		1.2		nC
ce Diode Characteristics :	and Maximum Ratings				
		<u> </u>	T	0.42	Α
rain-Source Diode Forward	$V_{GS} = 0 V, I_S = 0.42 A$ (Note 2)		0.72	1.2	V
	orward ate-Body Leakage Current, everse ate Threshold Voltage ate Threshold Voltage emperature Coefficient tatic Drain-Source n-Resistance n-State Drain Current orward Transconductance haracteristics put Capacitance utput Capacitance everse Transfer Capacitance Characteristics (Note 2) urn-On Delay Time urn-On Rise Time urn-Off Delay Time urn-Off Delay Time urn-Off Fall Time otal Gate Charge ate-Source Charge ate-Drain Charge <b>Ce Diode Characteristics a</b> aximum Continuous Drain-Source rain-Source Diode Forward oltage he junction-to-case and case-to-ambient therma	orwardVGS = -20 V, VDS = 0 Vate-Body Leakage Current, everseVGS = -20 V, VDS = 0 Vate-Body Leakage Current, everseVDS = VGS, ID = 0 Vate Threshold Voltage ate Threshold Voltage emperature CoefficientID = 250 $\mu$ A, Referenced to 25°Cate Threshold Voltage emperature CoefficientID = 250 $\mu$ A, Referenced to 25°Ctatic Drain-Source n-ResistanceVGS = 10 V, ID = 1.7 A, VGS = 10 V, ID = 1.7 A, VGS = 10 V, VDS = 1.7 Vn-State Drain CurrentVGS = 10 V, VDS = 1.7 Vpoward TransconductanceVDS = 10 V, ID = 1.7 Aharacteristics put CapacitanceVDS = 15 V, VGS = 0 V, f = 1.0 MHzf = 1.0 MHzVDS = 10 V, ID = 1.7 Aharacteristics (Note 2)VDD = 30 V, ID = 1 A, VGS = 10 V, RGEN = 6 \Omegaurn-On Delay Time urn-Off Fall TimeVDS = 20 V, ID = 1.7 A, VGS = 10 V, GS = 10 V, ID = 1.7 A, VGS = 1	brwardVGS = -20 V, VDS = 0 Vtate-Body Leakage Current, everseVGS = -20 V, VDS = 0 Vtate-Breshold VoltageVDS = VGS, ID = 250 $\mu$ A1tate Threshold VoltageID = 250 $\mu$ A, Referenced to 25°C1ate Threshold VoltageID = 250 $\mu$ A, Referenced to 25°C1ate Threshold VoltageID = 250 $\mu$ A, Referenced to 25°C1ate Threshold VoltageID = 250 $\mu$ A, Referenced to 25°C1ate Threshold VoltageID = 1.7 A1ate Threshold VoltageVGS = 10 V, ID = 1.7 A1n-ResistanceVGS = 10 V, VDS = 1.7 V5orward TransconductanceVDS = 10 V, ID = 1.7 A1haracteristicsVDS = 10 V, ID = 1.7 A1put CapacitanceVDS = 10 V, ID = 1.7 A1uput CapacitanceVDS = 10 V, ID = 1.7 A1uput CapacitanceVDS = 10 V, ID = 1.7 A1urn-On Delay TimeVDD = 30 V, ID = 1 A, VGS = 10 V, RGEN = 6 \Omega1urn-Off Delay TimeVDS = 20 V, ID = 1.7 A, VGS = 10 V, GS = 10 V,1ate-Drain ChargeVDS = 20 V, ID = 1.7 A, VGS = 10 V, GS = 10 V,ce Diode Characteristics and Maximum Ratings aximum Continuous Drain-Source Diode Forward Current rain-Source Diode Forward VGS = 0 V, IS = 0.42 A (Note 2)he junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the	powardVGS = -20 V, VDS = 0 Vdate-Body Leakage Current, everseVGS = -20 V, VDS = 0 Vdate-Body Leakage Current, everseVGS = -20 V, VDS = 0 Vde Threshold VoltageI ID = 250 µA, Referenced to 25°Cate Threshold VoltageID = 250 µA, Referenced to 25°Cate Threshold VoltageID = 250 µA, Referenced to 25°Camperature CoefficientID = 250 µA, Referenced to 25°Catic Drain-SourceVGS = 10 V, ID = 1.7 An-ResistanceVGS = 10 V, VDS = 1.7 Vn-ResistanceVDS = 10 V, VDS = 1.7 Vproverd TransconductanceVDS = 10 V, ID = 1.7 Aput CapacitanceVDS = 10 V, ID = 1.7 Aput CapacitanceVDS = 10 V, ID = 1.7 Auput CapacitanceVDD = 30 V, ID = 1.7 Auput CapacitanceVDD = 30 V, ID = 1 A,uput CapacitanceID = 20 UV, ID = 10 V, RGEN = 6 Ωurn-On Delay TimeVDD = 30 V, ID = 1.7 A,urn-Off Delay TimeID V, RGEN = 6 Ωiarn-Off Fall Time5otal Gate ChargeVDS = 20 V, ID = 1.7 A,vGS = 10 V,1.6ate-Drain Charge1.2ce Diode Characteristics and Maximum Ratingsaximum Continuous Drain-Source Diode Forward Current1.2rain-Source Diode ForwardVGS = 0 V, IS = 0.42 A (Note 2)otageVGS = 0 V, IS = 0.42 A (Note 2)0.72	DrivardVGS = -20 V, VDS = 0 V-100date-Body Leakage Current, everseVGS = -20 V, VDS = 0 V-100date-Body Leakage Current, everseVDS = VGS, ID = 250 $\mu$ A12.43date Threshold Voltage emperature CoefficientID = 250 $\mu$ A, Referenced to 25°C-6.9ate Threshold Voltage emperature CoefficientID = 250 $\mu$ A, Referenced to 25°C-6.9ate Threshold Voltage emperature CoefficientVGS = 10 V, ID = 1.7 A0.0730.100n-ResistanceVGS = 10 V, ID = 1.7 A0.0830.120n-State Drain CurrentVGS = 10 V, ID = 1.7 A6haracteristicsput CapacitanceVDS = 15 V, VGS = 0 V, f = 1.0 MHz400560uput CapacitanceVDS = 15 V, VGS = 0 V, f = 1.0 MHz400560uput CapacitanceVDS = 10 V, ID = 1.7 A615urn-On Delay Time urn-On Delay TimeVDD = 30 V, ID = 1 A, VGS = 10 V, RGEN = 6 \Omega1020urn-On Delay Time urn-Off Fall TimeVDS = 20 V, ID = 1.7 A, VGS = 10 V, MS = 10 V,1.615cc Diode Characteristics and Maximum Ratings aximum Continuous Drain-Source Diode Forward Current0.420.721.2ct DidageVGS = 0 V, IS = 0.42 A (Note 2)0.721.21.2



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